

CY28412

Clock Generator for Intel[®] Grantsdale Chipset

Features

- Supports Intel[®] P4 and Prescott CPU
- Selectable CPU frequencies
- Differential CPU clock pairs
- 100 MHz differential SRC clocks
- 96 MHz differential dot clock
- 48 MHz USB clocks
- 33 MHz PCI clock

- Low-voltage frequency select input
- I²C Support with read back capabilities
- Ideal Lexmark Spread Spectrum profile for maximum electromagnetic interference (EMI) reduction
- 3.3V power supply
- 56-pin SSOP package

Pin Configuration

ſ	CPU	SRC	PCI	REF	DOT96	USB_48
	x2 / x3	x7 / x8	x 8	x 2	x 1	x 1

- VDD REF PCI0 C 1 56 □ VDD REF XIN XTAL OSC + REF[1:0] □ REF0/FS_C PCI1 C 2 55 XOUT PLL Ref Freq □ REF1/FS A VDD PCI 3 54 VDD_CPU GND_PCI □ 4 53 □ GND_REF CPUT[0:1], CPUC[0:1], CPU(T/C)2_ITP] VDD_SRC CPU STP# Divider PLL1 PCI2 52 5 ⊐ X1 PCI STP# Network PCI3 51 ⊐ X2 6 SRCT[0:6], SRCC[0:6], PCI4 □ SDATA 50 7 FS_[C:A] VTT PWRGD#-SATA[T/C] PCI5 [8 49 □ SCLK GND PCI C 48 GND CPU IREF 9 VDD_PCI 47 □ CPUT0 10 VDD_PCI CPUC0 TEST SEL/PCIF0 □ 11 46 PCI[0:5] ITP_EN/PCIF1 UDD_CPU 45 VDD_PCIF 12 CY28412 VDD 48 🗆 PCIF[0:1] 13 44 □ CPUT1 USB48/FS B 14 43 □ CPUC1 GND 48 □ 42 15 □ IREF PD VDD 48 MHz DOT96T □ 41 ⊐ GND A 16 DOT96T DOT96C DOT96C 17 40 PLL2 □ CPUT2_ITP/SRCT6 VTT PwrGd#/PD 18 39 USB 48 SRCT0 [38 □ CPUC2_ITP/SRCC6 19 SRCC0 □ 20 37 ⊐VDD SRC 36 SRCT1 □ 21 ⊐ SRCT5 22 35 □ SRCC5 STCC1 [VDD_SRC □ 34 □ GND_SRC 23 GND SRC 24 33 □ SRCT4 SRCT2 □ 25 32 □ SRCC4 SRCC2 26 31 □ SRCT3 SDATA 1²C SATAT [30 ⊐ SRCC3 27 SCLK-Logic SATAC [28 29 □ VDD_SRC **56 SSOP**

Block Diagram





Pin Definitions

Pin No.	Name	Туре	Description	
47,46,44,43	CPUT/C	O, DIF	Differential CPU clock outputs.	
39,38	CPUT2_ITP/SRCT6, CPUC2_ITP/SRCC6	O, DIF	Selectable Differential CPU or SRC clock output. ITP_EN = 0 @ VTT_PWRGD# assertion = SRC6 ITP_EN = 1 @ VTT_PWRGD# assertion = CPU2	
16,17	DOT96T, DOT96C	O, DIF	Fixed 96-MHz clock output.	
55, 54 REF0/FS_C, I/O REF1/FS_A		I/O	14.318-MHz reference clock/3.3V-tolerant input for CPU frequency selection. Input is latched upon assertion (LOW) of VTT_PWRGD#/PD Refer to DC Electrical Specifications table for Vil_FS and Vih_FS specifications	
14	USB48/FS_B	I/O	Fixed 48-MHz USB clock output/3.3V-tolerant input for CPU frequency selection. Input is latched upon assertion (LOW) of VTT_PWRGD#/PD Refer to DC Electrical Specifications table for Vil_FS and Vih_FS specifications	
42	IREF	I	A precision resistor is attached to this pin, which is connected to the internal current reference.	
1,2,5,6,7,8	PCI[0:5]	O, SE	33-MHz clocks.	
11	TEST_SEL/PCIF0	I/O	Free-running 33-MHz clocks/ 3.3V-tolerant input for selecting test mode. Input is latched upon assertion (LOW) of VTT_PWRGD#/PD 1 = All outputs are three-stated for test 0 = All outputs normal operation **This input has an internal pull-down resistor.	
12	ITP_EN/PCIF1	I/O, SE	Free-running 33-MHz clock/CPU2 select (sampled on the VTT_PWRGD# assertion). 1 = CPU2_ITP, 0 = SRC6	
49	SCLK	I	SMBus-compatible SCLOCK.	
50	SDATA	I/O	SMBus-compatible SDATA.	
27,28	SATAT, SATAC	O, DIF	Differential serial reference clock. Recommended output for SATA.	
19,20,21,22, 25,26,30,31, 32,33,35,36	SRCT/C[0:5]	O, DIF	Differential serial reference clocks.	
13	VDD_48	PWR	3.3V power supply for outputs.	
45	VDD_CPU	PWR	3.3V power supply for outputs.	
3,10	VDD_PCI	PWR	3.3V power supply for outputs.	
56	VDD_REF	PWR	3.3V power supply for outputs.	
23,29,37	VDD_SRC	PWR	3.3V power supply for outputs.	
40	VDD_A	PWR	3.3V power supply for PLL.	
15	GND_48	GND	Ground for outputs.	
48	GND_CPU	GND	Ground for outputs.	
4,9	GND_PCI	GND	Ground for outputs.	
53	GND_REF	GND	Ground for outputs.	
24,34	 GND_SRC	GND	D Ground for outputs.	
41	 GND_A	GND		
18	VTT_PWRGD#/PD	I, PU	3.3V LVTTL input is a level sensitive strobe used to latch the REF0/FSC, REF1/FSA, USB48/FSB, TEST_SEL/PCIF0 and ITP_EN/PCIF1 inputs. After VTT_PWRGD# (active LOW) assertion, this pin becomes a realtime input for asserting power-down (active HIGH).	
52	X1	I	14.318-MHz crystal input.	
51	X2	O, SE	14.318-MHz crystal output.	



Frequency Select Pins (FS_A, FS_B and FS_C)

Host clock frequency selection is achieved by applying the appropriate logic levels to FS_A, FS_B, FS_C inputs prior to VTT_PWRGD# assertion (as seen by the clock synthesizer). Upon VTT_PWRGD# being sampled low by the clock chip (indicating processor VTT voltage is stable), the clock chip samples the FS_A, FS_B and FS_C input values. For all logic levels of FS_A, FS_B and FS_C VTT_PWRGD# employs a one-shot functionality in that once a valid low on VTT_PWRGD# has been sampled, all further VTT_PWRGD#, FS_A, FS_B and FS_C transitions will be ignored, except in test mode.

Serial Data Interface

To enhance the flexibility and function of the clock synthesizer, a two-signal serial interface is provided. Through the Serial Data Interface, various device functions, such as individual clock output buffers, can be individually enabled or disabled. The registers associated with the Serial Data Interface initial-

Table 1. Frequency Select Table (FS_A, FS_B, FS_C)

izes to their default setting upon power-up, and therefore use of this interface is optional. Clock device register changes are normally made upon system initialization, if any are required. The interface cannot be used during system operation for power management functions.

Data Protocol

The clock driver serial protocol accepts byte write, byte read, block write, and block read operations from the controller. For block write/read operation, the bytes must be accessed in sequential order from lowest to highest byte (most significant bit first) with the ability to stop after any complete byte has been transferred. For byte write and byte read operations, the system controller can access individually indexed bytes. The offset of the indexed byte is encoded in the command code, as described in *Table 2*.

The block write and block read protocol is outlined in *Table 3* while *Table 4* outlines the corresponding byte write and byte read protocol. The slave receiver address is 11010010 (D2h).

FS_C	FS_B	FS_A	CPU	SRC	PCIF/PCI	REF0	DOT96	USB
1	0	1	100 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	0	1	133 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	1	1	166 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	1	0	200 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
0	0	0	266 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
1	0	0	333 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
1	1	0	400 MHz	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz
1	1	1	Reserved	100 MHz	33 MHz	14.318 MHz	96 MHz	48 MHz

Table 2. Command Code Definition

Bit	Description
7	0 = Block read or block write operation, 1 = Byte read or byte write operation
(6:0)	Byte offset for byte read or byte write operation. For block read or block write operations, these bits should be '0000000'

Table 3. Block Read and Block Write Protocol

	Block Write Protocol		Block Read Protocol	
Bit	Description	Bit	Description	
1	Start	1	Start	
2:8	Slave address – 7 bits	2:8	Slave address – 7 bits	
9	Write = 0	9	Write = 0	
10	Acknowledge from slave	10	Acknowledge from slave	
11:18	Command Code – 8 bits '00000000' stands for block operation	11:18	Command Code – 8 bits '00000000' stands for block operation	
19	Acknowledge from slave	19	Acknowledge from slave	
20:27	Byte Count – 8 bits	20	Repeat start	
28	Acknowledge from slave	21:27	Slave address – 7 bits	
29:36	Data byte 1 – 8 bits	28	Read = 1	
37	Acknowledge from slave	29	Acknowledge from slave	
38:45	Data byte 2 – 8 bits	30:37	Byte count from slave – 8 bits	
46	Acknowledge from slave	38	Acknowledge from master	



Table 3. Block Read and Block Write Protocol (continued)

	Block Write Protocol	Block Read Protocol		
Bit	Description	Bit	Description	
		39:46	Data byte from slave – 8 bits	
	Data Byte (N – 1) – 8 bits	47	Acknowledge from master	
	Acknowledge from slave	48:55	Data byte from slave – 8 bits	
	Data Byte N – 8 bits	56	Acknowledge from master	
	Acknowledge from slave		Data byte N from slave – 8 bits	
	Stop		Acknowledge from master	
			Stop	

Table 4. Byte Read and Byte Write Protocol

	Byte Write Protocol		Byte Read Protocol
Bit	Description	Bit	Description
1	Start	1	Start
2:8	Slave address – 7 bits	2:8	Slave address – 7 bits
9	Write = 0	9	Write = 0
10	Acknowledge from slave	10	Acknowledge from slave
11:18	Command Code – 8 bits '100xxxxx' stands for byte operation, bits[6:0] of the command code represents the offset of the byte to be accessed	11:18	Command Code – 8 bits '100xxxxx' stands for byte operation, bits[6:0] of the command code represents the offset of the byte to be accessed
19	Acknowledge from slave	19	Acknowledge from slave
20:27	Data byte from master – 8 bits	20	Repeat start
28	Acknowledge from slave	21:27	Slave address – 7 bits
29	Stop	28	Read = 1
		29	Acknowledge from slave
		30:37	Data byte from slave – 8 bits
		38	Acknowledge from master
		39	Stop

Control Registers Byte 0:Control Register 0

Bit	@Pup	Name	Description	
7	1	CPUT2_ITP/SRCT6 CPUC2_ITP/SRCC6	CPU[T/C]2_ITP/SRC[T/C]6 Output Enable 0 = Disable (Hi-Z), 1 = Enable	
6	1	SRC[T/C]5	SRC[T/C]5 Output Enable 0 = Disable (Hi-Z), 1 = Enable	
5	1	SRC[T/C]4	SRC[T/C]4 Output Enable 0 = Disable (Hi-Z), 1 = Enable	
4	1	SRC[T/C]3	SRC[T/C]3 Output Enable 0 = Disable (Hi-Z), 1 = Enable	
3	1	SATAT/C]	SATA[T/C] Output Enable 0 = Disable (Hi-Z), 1 = Enable	
2	1	SRC[T/C]2	SRC[T/C]2 Output Enable 0 = Disable (Hi-Z), 1 = Enable	
1	1	SRC[T/C]1	SRC[T/C]1 Output Enable 0 = Disable (Hi-Z), 1 = Enable	
0	1	SRC[T/C]0	SRC[T/C]0 Output Enable 0 = Disable (Hi-Z), 1 = Enable	





Byte 1: Control Register 1

Bit	@Pup	Name	Description
7	1	CPUT/C SRCT/C PCIF PCI	Center Spread Enable 0 = ±0.25% Center Spread, 1 = –0.5% Down Spread
6	1	DOT_96T/C	DOT_96 MHz Output Enable 0 = Disable (Hi-Z), 1 = Enabled
5	1	USB_48	USB_48 MHz Output Enable 0 = Disabled, 1 = Enabled
4	1	REF0	REF0 Output Enable 0 = Disabled, 1 = Enabled
3	1	REF1	REF1 Output Enable 0 = Disabled, 1 = Enabled
2	1	CPU[T/C]1	CPU[T/C]1 Output Enable 0 = Disable (Hi-Z), 1 = Enabled
1	1	CPU[T/C]0	CPU[T/C]0 Output Enable 0 = Disable (Hi-Z), 1 = Enabled
0	0	CPUT/C SRCT/C PCIF PCI	Spread Spectrum Enable 0 = Spread off, 1 = Spread on

Byte 2: Control Register 2

Bit	@Pup	Name	Description
7	1	PCI5	PCI5 Output Enable 0 = Disabled, 1 = Enabled
6	1	PCI4	PCI4 Output Enable 0 = Disabled, 1 = Enabled
5	1	PCI3	PCI3 Output Enable 0 = Disabled, 1 = Enabled
4	1	PCI2	PCI2 Output Enable 0 = Disabled, 1 = Enabled
3	1	PCI1	PCI1 Output Enable 0 = Disabled, 1 = Enabled
2	1	PCI0	PCI0 Output Enable 0 = Disabled, 1 = Enabled
1	1	PCIF1	PCIF1 Output Enable 0 = Disabled, 1 = Enabled
0	1	PCIF0	PCIF0 Output Enable 0 = Disabled, 1 = Enabled

Byte 3: Control Register 3

Bit	@Pup	Name	Description
7	0	CPUT2_ITP/SRCT6 CPUC2_ITP/SRCC6	Allow control of SRC[T/C]6 with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
6	0	SRC[T/C]5	Allow control of SRC[T/C]5with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
5	0	SRC[T/C]4	Allow control of SRC[T/C]4 with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
4	0	SRC[T/C]3	Allow control of SRC[T/C]3with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
3	0	SATA[T/C]	Allow control of SATA[T/C] with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#





Byte 3: Control Register 3 (continued)

Bit	@Pup	Name	Description
2	0	SRC2	Allow control of SRC[T/C]2 with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
1	0	SRC1	Allow control of SRC[T/C]1 with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
0	0	SRC0	Allow control of SRC[T/C]0 with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#

Byte 4: Control Register 4

Bit	@Pup	Name	Description
7	0	RESERVED	RESERVED, Set = 0
6	0	DOT96[T/C]	DOT_PWRDWN Drive Mode 0 = Driven in PWRDWN, 1 = Hi-Z
5	0	PCIF1	Allow control of PCIF2 with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
4	0	PCIF0	Allow control of PCIF1 with assertion of SW PCI_STP# 0 = Free-running, 1 = Stopped with SW PCI_STP#
3	0	RESERVED	RESERVED, Set = 0
2	1	RESERVED	RESERVED, Set = 1
1	1	RESERVED	RESERVED, Set = 1
0	1	RESERVED	RESERVED, Set = 1

Byte 5: Control Register 5

Bit	@Pup	Name	Description
7	0	SRC[T/C][6:0],SATA[T/C]	SRC[T/C], SATA[T/C]Stop Drive Mode 0 = Driven when SW PCI_STP# asserted,1 = Hi-Z when PCI_STP# asserted
6	0	RESERVED	RESERVED, Set = 0
5	0	RESERVED	RESERVED, Set = 0
4	0	RESERVED	RESERVED, Set = 0
3	0	SRC[T/C][6:0],SATA[T/C]	SRC[T/C], SATA[T/C] PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Hi-Z when PD asserted
2	0	CPU[T/C]2	CPU[T/C]2 PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Hi-Z when PD asserted
1	0	CPU[T/C]1	CPU[T/C]1 PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Hi-Z when PD asserted
0	0	CPU[T/C]0	CPU[T/C]0 PWRDWN Drive Mode 0 = Driven when PD asserted,1 = Hi-Z when PD asserted





Byte 6: Control Register 6

Bit	@Pup	Name	Description
7	0	RESERVED	RESERVED, Set = 0
6	0		Test Clock Mode Entry Control 1 = Hi-Z mode, 0 = Normal operation
5	1	REF1	REF1 Output Drive Strength 0 = Low, 1 = High
4	1	REF0	REF0 Output Drive Strength 0 = Low, 1 = High
3	1	PCIF, SRC, PCI	SW PCI_STP# Function 0=SW PCI_STP assert, 1= SW PCI_STP deassert When this bit is set to 0, all STOPPABLE PCI, PCIF and SRC outputs will be stopped in a synchronous manner with no short pulses. When this bit is set to 1, all STOPPED PCI, PCIF and SRC outputs will resume in a synchronous manner with no short pulses.
2	Externally selected	CPUT/C	FS_C. Reflects the value of the FS_C pin sampled on power up 0 = FS_C was low during VTT_PWRGD# assertion
1	Externally selected	CPUT/C	FS_B. Reflects the value of the FS_B pin sampled on power up 0 = FS_B was low during VTT_PWRGD# assertion
0	Externally selected	CPUT/C	FS_A. Reflects the value of the FS_A pin sampled on power up 0 = FS_A was low during VTT_PWRGD# assertion

Byte 7: Vendor ID

Bit	@Pup	Name	Description
7	0	Revision Code Bit 3	Revision Code Bit 3
6	0	Revision Code Bit 2	Revision Code Bit 2
5	1	Revision Code Bit 1	Revision Code Bit 1
4	0	Revision Code Bit 0	Revision Code Bit 0
3	1	Vendor ID Bit 3	Vendor ID Bit 3
2	0	Vendor ID Bit 2	Vendor ID Bit 2
1	0	Vendor ID Bit 1	Vendor ID Bit 1
0	0	Vendor ID Bit 0	Vendor ID Bit 0

Crystal Recommendations

The CY28412 requires a **Parallel Resonance Crystal**. Substituting a series resonance crystal will cause the CY28412 to operate at the wrong frequency and violate the ppm specification. For most applications there is a 300-ppm frequency shift between series and parallel crystals due to incorrect loading.

Crystal Loading

Crystal loading plays a critical role in achieving low ppm performance. To realize low ppm performance, the total capacitance the crystal will see must be considered to calculate the appropriate capacitive loading (CL).

The following diagram shows a typical crystal configuration using the two trim capacitors. An important clarification for the following discussion is that the trim capacitors are in series with the crystal not parallel. It's a common misconception that load capacitors are in parallel with the crystal and should be approximately equal to the load capacitance of the crystal. This is not true.

Table 5. Crystal Recommendations

Frequency (Fund)	Cut	Loading	Load Cap	Drive (max.)	Shunt Cap (max.)	Motional (max.)	Tolerance (max.)	Stability (max.)	Aging (max.)
14.31818 MHz	AT	Parallel	20 pF	0.1 mW	5 pF	0.016 pF	50 ppm	50 ppm	5 ppm



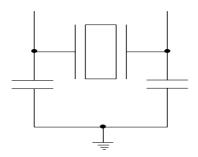


Figure 1. Crystal Capacitive Clarification

Calculating Load Capacitors

In addition to the standard external trim capacitors, trace capacitance and pin capacitance must also be considered to correctly calculate crystal loading. As mentioned previously, the capacitance on each side of the crystal is in series with the crystal. This means the total capacitance on each side of the crystal load capacitance (CL). While the capacitance on each side of the crystal is in series with the crystal, trim capacitors (Ce1,Ce2) should be calculated to provide equal capacitive loading on both sides.

As mentioned previously, the capacitance on each side of the crystal is in series with the crystal. This mean the total capacitance on each side of the crystal must be 2 times the specified load capacitance (CL). While the capacitance on each side of the crystal is in series with the crystal, trim capacitors (Ce1,Ce2) should be calculated to provide equal capacitance loading on both sides.

Use the following formulas to calculate the trim capacitor values for Ce1 and Ce2.

Load Capacitance (each side)

Ce = 2 * CL - (Cs + Ci)

Total Capacitance (as seen by the crystal)

$$CLe = \frac{1}{\left(\frac{1}{Ce^{1} + Cs^{1} + Ci^{1}} + \frac{1}{Ce^{2} + Cs^{2} + Ci^{2}}\right)}$$
CLCrystal load capacitance

CLeActual loading seen by crystal using standard value trim capacitors

CeExternal trim capacitors CsStray capacitance (terraced)

Ci Internal capacitance (lead frame, bond wires etc.)

PD (Power-down) Clarification

The VTT_PWRGD# /PD pin is a dual function pin. During initial power-up, the pin functions as VTT_PWRGD#. Once VTT_PWRGD# has been sampled low by the clock chip, the pin assumes PD functionality. The PD pin is an asynchronous active high input used to shut off all clocks cleanly prior to shutting off power to the device. This signal is synchronized internal to the device prior to powering down the clock synthesizer. PD is also an asynchronous input for powering up the system. When PD is asserted high, all clocks are driven to a low value and held prior to turning off the VCOs and the crystal oscillator.

PD (Power-down) – Assertion

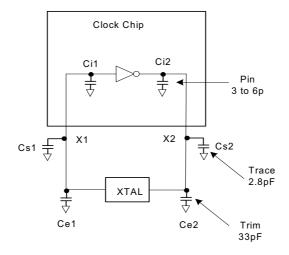
When PD is sampled high by two consecutive rising edges of CPUC, all single-ended outputs will be held low on their next high to low transition and differential clocks must be held high or Hi-Z (depending on the state of the control register drive mode bit) on the next diff clock# high to low transition. When the SMBus PD drive mode bit corresponding to the differential (CPU, SRC, and DOT) clock output of interest is programmed to '0', the clock output must be held with "Diff clock" pin driven high at 2 x Iref, and "Diff clock#" tristate. If the control register PD drive mode bit corresponding to the output of interest is programmed to "1", then both the "Diff clock" and the "Diff clock#" are Hi-Z. Note the example below shows CPUT = 133 MHz and PD drive mode = '1' for all differential outputs. This diagram and description is applicable to valid CPU frequencies 100,133,166,200,266,333, and 400 MHz. In the event that PD mode is desired as the initial power-on state, PD must be asserted high in less than 10 μ s after asserting VTT PWRGD#.



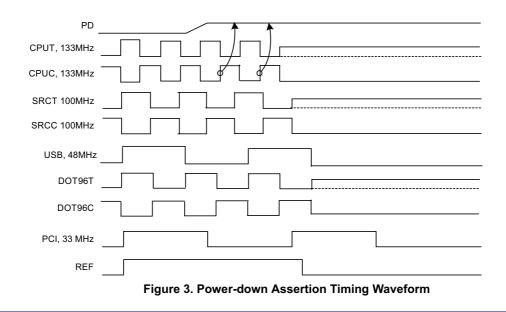


PD Deassertion

The power-up latency is less than 1.8 ms. This is the time from the deassertion of the PD pin or the ramping of the power supply until the time that stable clocks are output from the clock chip. All differential outputs stopped in a tristate condition resulting from power down must be driven high in less than 300 μs of PD deassertion to a voltage greater than 200 mV. After the clock chip's internal PLL is powered up and locked, all outputs are enabled within a few clock cycles of each other.







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Below is an example showing the relationship of clocks coming up.

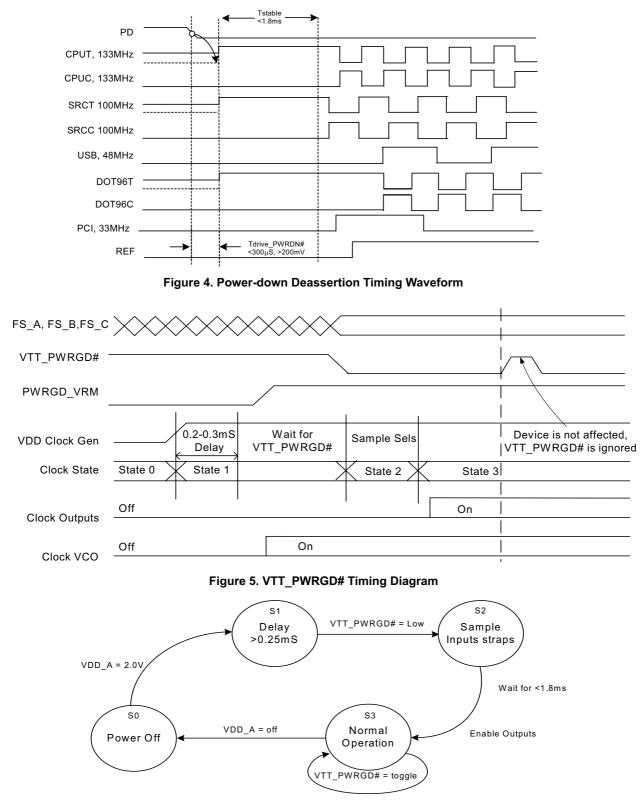


Figure 6. Clock Generator Power-up/Run State Diagram

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Absolute Maximum Conditions

Parameter	Description	Condition	Min.	Max.	Unit
V _{DD}	Core Supply Voltage		-0.5	4.6	V
V _{DD_A}	Analog Supply Voltage		-0.5	4.6	V
V _{IN}	Input Voltage	Relative to V _{SS}	-0.5	V _{DD} + 0.5	VDC
Τ _S	Temperature, Storage	Non-functional	-65	150	°C
T _A	Temperature, Operating Ambient	Functional	0	70	°C
Tj	Temperature, Junction	Functional	-	150	°C
Ø _{JC}	Dissipation, Junction to Case	Mil-Spec 883E Method 1012.1	-	31.89	°C/W
Ø _{JA}	Dissipation, Junction to Ambient	JEDEC (JESD 51)	-	48.29	°C/W
ESD _{HBM}	ESD Protection (Human Body Model)	MIL-STD-883, Method 3015	2000	-	V
UL-94	Flammability Rating	At 1/8 in.		V-0	
MSL	Moisture Sensitivity Level			1	

Multiple Supplies: The Voltage on any input or I/O pin cannot exceed the power pin during power-up. Power supply sequencing is NOT required.

DC Electrical Specifications

Parameter	Description	Condition	Min.	Max.	Unit
VDD_A VDD_REF, VDD_PCI, VDD_3V66, VDD_48, VDD_CPU	3.3V Operating Voltage	3.3 ± 5%	3.135	3.465	V
V _{ILI2C}	Input Low Voltage	SDATA, SCLK	-	1.0	V
V _{IHI2C}	Input High Voltage	SDATA, SCLK	2.2	-	V
V _{IL_FS}	FS_(A,B,C) Input Low Voltage		$V_{SS} - 0.3$	0.35	V
V _{IH_FS}	FS_(A,B,C) Input High Voltage		0.7	V _{DD} + 0.5	V
V _{IL}	Input Low Voltage		$V_{SS} - 0.5$	0.8	V
V _{IH}	Input High Voltage		2.0	V _{DD} + 0.5	V
IIL	Input Low Leakage Current	except internal pull-up resistors, 0 < V _{IN} < V _{DD}	-5		μA
I _{IH}	Input High Leakage Current	except internal pull-down resistors, $0 < V_{IN} < V_{DD}$		5	μA
V _{OL}	Output Low Voltage	I _{OL} = 1 mA	-	0.4	V
V _{OH}	Output High Voltage	I _{OH} = -1 mA	2.4	-	V
I _{OZ}	High-impedance Output Current		-10	10	μA
C _{IN}	Input Pin Capacitance		2	5	pF
C _{OUT}	Output Pin Capacitance		3	6	pF
L _{IN}	Pin Inductance		-	7	nH
V _{XIH}	Xin High Voltage		0.7V _{DD}	V _{DD}	V
V _{XIL}	Xin Low Voltage		0	0.3V _{DD}	V
I _{DD3.3V}	Dynamic Supply Current	At max load and freq per Figure 8	-	500	mA
I _{PD3.3V}	Power-down Supply Current	PD asserted, Outputs driven	_	75	mA
I _{PD3.3V}	Power-down Supply Current	PD asserted, Outputs Hi-Z	-	2	mA



AC Electrical Specifications

Parameter	Description	Condition	Min.	Max.	Unit
Crystal					
T _{DC}	XIN Duty Cycle	The device will operate reliably with input duty cycles up to 30/70 but the REF clock duty cycle will not be within specification	47.5	52.5	%
T _{PERIOD}	XIN Period	When XIN is driven from an external clock source	69.841	71.0	ns
T _R / T _F	XIN Rise and Fall Times	Measured between $0.3V_{DD}$ and $0.7V_{DD}$	_	10.0	ns
T _{CCJ}	XIN Cycle to Cycle Jitter	As an average over 1-µs duration	_	500	ps
L _{ACC}	Long-term Accuracy	Over 150 ms	-	300	ppm
CPU at 0.7	V				•
T _{DC}	CPUT and CPUC Duty Cycle	Measured at crossing point V _{OX}	45	55	%
T _{PERIOD}	100 MHz CPUT and CPUC Period	Measured at crossing point V _{OX}	9.9970	10.003	ns
T _{PERIOD}	133 MHz CPUT and CPUC Period	Measured at crossing point V _{OX}	7.4978	7.5023	ns
T _{PERIOD}	166 MHz CPUT and CPUC Period	Measured at crossing point V _{OX}	5.9982	6.0018	ns
T _{PERIOD}	200 MHz CPUT and CPUC Period	Measured at crossing point V _{OX}	4.9985	5.0015	ns
T _{PERIOD}	266 MHz CPUT and CPUC Period	Measured at crossing point V _{OX}	3.7489	3.7511	ns
T _{PERIOD}	333 MHz CPUT and CPUC Period	Measured at crossing point V _{OX}	2.9991	3.0009	ns
T _{PERIOD}	400 MHz CPUT and CPUC Period	Measured at crossing point V _{OX}	2.4993	2.5008	ns
T _{PERIODSS}	100 MHz CPUT and CPUC Period, SSC	Measured at crossing point V _{OX}	9.9970	10.0533	ns
TPERIODSS		Measured at crossing point V _{OX}	7.4978	7.5400	ns
T _{PERIODSS}		Measured at crossing point V _{OX}	5.9982	6.0320	ns
	200 MHz CPUT and CPUC Period, SSC		4.9985	5.0266	ns
	266 MHz CPUT and CPUC Period, SSC		3.7489	3.7700	ns
			2.9991	3.0160	ns
			2.4993	2.5133	ns
T _{SKEW}	Any CPUT/C to CPUT/C Clock Skew, SSC	Measured at crossing point V _{OX}	_	100	ps
T _{CCJ}	CPUT/C Cycle to Cycle Jitter	Measured at crossing point V _{OX}	_	85	ps
T _{CCJ2}	CPU2_ITP Cycle to Cycle Jitter	Measured at crossing point V _{OX}	_	125	ps
T _{SKEW2}	CPU2_ITP to CPU0 Clock Skew	Measured at crossing point V _{OX}	_	150	ps
T _R / T _F	CPUT and CPUC Rise and Fall Times	Measured from V_{OL} = 0.175 to V_{OH} = 0.525V	175	700	ps
T _{RFM}	Rise/Fall Matching	Determined as a fraction of $2^{*}(T_{R} - T_{F})/(T_{R} + T_{F})$	_	20	%
ΔT _R	Rise Time Variation		_	125	ps
ΔT _F	Fall Time Variation		_	125	ps
V _{HIGH}	Voltage High	Math averages Figure 8	660	850	mv
V _{LOW}	Voltage Low	Math averages <i>Figure</i> 8	-150	_	mv
V _{OX}	Crossing Point Voltage at 0.7V Swing		250	550	mv
V _{OVS}	Maximum Overshoot Voltage		_	V _{HIGH} + 0.3	V
V _{UDS}	Minimum Undershoot Voltage		-0.3	_	V
V _{RB}	Ring Back Voltage	See Figure 8. Measure SE	_	0.2	V
SRC	0	3	<u> </u>		-
T _{DC}	SRCT and SRCC Duty Cycle	Measured at crossing point V _{OX}	45	55	%
T _{PERIOD}	100 MHz SRCT and SRCC Period	Measured at crossing point V_{OX}	9.9970	10.003	ns
T _{PERIOD}	100 MHz SRCT and SRCC Period, SSC	Measured at crossing point V_{OX}	9.9970	10.0533	ns



AC Electrical Specifications (continued)

Parameter	Description	Condition	Min.	Max.	Unit
T _{CCJ}	SRCT/C Cycle to Cycle Jitter	Measured at crossing point V _{OX}	_	125	ps
L _{ACC}	SRCT/C Long Term Accuracy	Measured at crossing point V _{OX}	_	300	ppm
T _R / T _F	SRCT and SRCC Rise and Fall Times	Measured from V _{OL} = 0.175 to V _{OH} = 0.525V	175	700	ps
T _{RFM}	Rise/Fall Matching	Determined as a fraction of $2^{(T_R - T_F)/(T_R + T_F)}$	_	20	%
ΔT _R	Rise Time Variation		-	125	ps
ΔT_F	Fall Time Variation		_	125	ps
V _{HIGH}	Voltage High	Math averages Figure 8	660	850	mv
V _{LOW}	Voltage Low	Math averages Figure 8	-150	_	mv
V _{OX}	Crossing Point Voltage at 0.7V Swing		250	550	mV
V _{OVS}	Maximum Overshoot Voltage		-	V _{HIGH} + 0.3	V
V _{UDS}	Minimum Undershoot Voltage		-0.3	_	V
V _{RB}	Ring Back Voltage	See Figure 8. Measure SE	_	0.2	V
T _{SKEW}	Any SRCT/C to SRCT/C Clock Skew	Measured at Crossing point V _{OX}	_	250	ps
PCI/PCIF					
T _{DC}	PCI Duty Cycle	Measurement at 1.5V	45	55	%
T _{PERIOD}	Spread Disabled PCIF/PCI Period	Measurement at 1.5V	29.9910	30.0090	ns
T _{PERIOD}	Spread Enabled PCIF/PCI Period	Measurement at 1.5V	29.9910	30.1598	ns
T _{HIGH}	PCIF and PCI high time	Measurement at 2.4V	12.0	_	ns
T _{LOW}	PCIF and PCI low time	Measurement at 0.4V	12.0	_	ns
T _R / T _F	PCIF and PCI Edge Rate	Measured between 0.8V and 2.0V	0.5	2.0	V/ns
T _{SKEW}	Any PCI clock to Any PCI clock Skew	Measurement at 1.5V	_	500	ps
T _{CCJ}	PCIF and PCI Cycle to Cycle Jitter	Measurement at 1.5V	_	500	ps
DOT					
T _{DC}	DOT96T and DOT96C Duty Cycle	Measured at crossing point V _{OX}	45	55	%
T _{PERIOD}	DOT96T and DOT96C Period	Measured at crossing point V _{OX}	10.4135	10.4198	ns
T _{CCJ}	DOT96T/C Cycle to Cycle Jitter	Measured at crossing point V _{OX}	_	250	ps
L _{ACC}	DOT96T/C Long Term Accuracy	Measured at crossing point V_{OX}	-	300	ppm
T _R / T _F	DOT96T and DOT96C Rise and Fall Times	Measured from V_{OL} = 0.175 to V_{OH} = 0.525V	175	700	ps
T _{RFM}	Rise/Fall Matching	Determined as a fraction of $2^{(T_R - T_F)/(T_R + T_F)}$	_	20	%
ΔT_R	Rise Time Variation		_	125	ps
ΔT_F	Fall Time Variation		_	125	ps
V _{HIGH}	Voltage High	Math averages Figure 8	660	850	mv
V _{LOW}	Voltage Low	Math averages Figure 8	-150	_	mv
V _{OX}	Crossing Point Voltage at 0.7V Swing		250	550	mV
V _{OVS}	Maximum Overshoot Voltage		-	V _{HIGH} + 0.3	V
V _{UDS}	Minimum Undershoot Voltage		-0.3	_	V
V _{RB}	Ring Back Voltage	See Figure 8. Measure SE	-	0.2	V
USB					-1
T _{DC}	Duty Cycle	Measurement at 1.5V	45	55	%
T _{PERIOD}	Period	Measurement at 1.5V	20.8271	20.8396	ns
T _{HIGH}	USB high time	Measurement at 2.4V	8.094	10.036	ns
T _{LOW}	USB low time	Measurement at 0.4V	7.694	9.836	ns

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AC Electrical Specifications (continued)

Parameter	Description	Condition	Min.	Max.	Unit
T _R / T _F	USB Edge Rate	Measured between 0.8V and 2.0V	1.0	2.0	V/ns
T _{CCJ}	USB Cycle to Cycle Jitter	Measurement at 1.5V	-	350	ps
REF			I		
T _{DC}	REF Duty Cycle	Measurement at 1.5V	45	55	%
T _{PERIOD}	REF Period	Measurement at 1.5V	69.8203	69.8622	ns
T _R / T _F	REF Edge Rate	Measured between 0.8V and 2.0V	0.5	2.0	V/ns
T _{CCJ}	REF Cycle to Cycle Jitter	Measurement at 1.5V	-	1000	ps
ENABLE/D	ISABLE and SETUP	· ·	·		
T _{STABLE}	Clock Stabilization from Power-up		-	1.8	ms
T _{SS}	Stopclock Set-up Time		10.0	-	ns
T _{SH}	Stopclock Hold Time		0	-	ns

Test and Measurement Set-up

For PCI Single-ended Signals and Reference

The following diagram shows the test load configurations for the single-ended PCI, USB, and REF output signals.

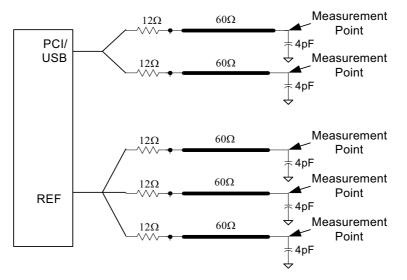


Figure 7. Single-ended Load Configuration





For Differential CPU, SRC and DOT96 Output Signals

The following diagram shows the test load configuration for the differential CPU and SRC outputs.

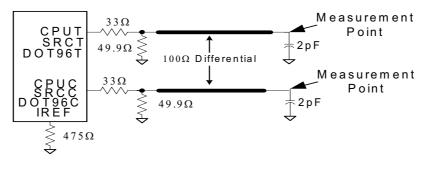


Figure 8. 0.7V Single-ended Load Configuration

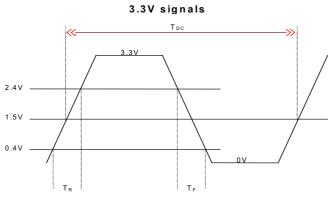


Figure 9. Single-ended Output Signals (for AC Parameters Measurement)

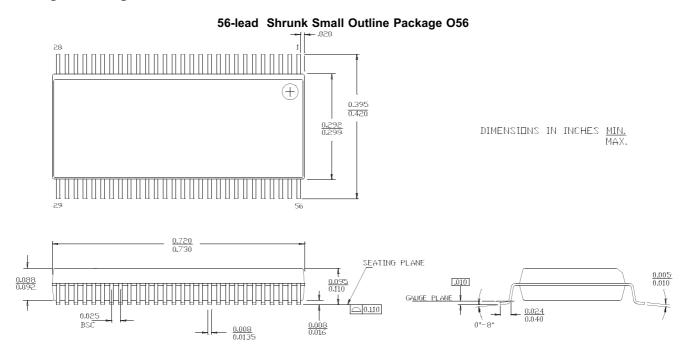




Ordering Information

Part Number	Package Type	Product Flow
Standard		·
CY28412OC	56-pin SSOP	Commercial, 0° to 70°C
CY28412OCT	56-pin SSOP – Tape and Reel	Commercial, 0° to 70°C
Lead-free		·
CY28412OXC	56-pin SSOP	Commercial, 0° to 70°C
CY28412OXCT	56-pin SSOP – Tape and Reel	Commercial, 0° to 70°C

Package Drawing and Dimensions



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